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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/635,651	08/07/2003	Taro Ikeda	033082R167 8788 EXAMINER		
441	7590 06/14/2006				
SMITH, GAMBRELL & RUSSELL, LLP 1850 M STREET, N.W., SUITE 800			ALEJANDRO MULERO, LUZ L		
	ON, DC 20036		ART UNIT	PAPER NUMBER	
	•		1763		
			DATE MAILED: 06/14/2000	DATE MAILED: 06/14/2006	

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)					
	10/635,651	IKEDA, TARO					
Office Action Summary	Examiner	Art Unit					
	Luz L. Alejandro	1763					
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the c	orrespondence address					
A SHORTENED STATUTORY PERIOD FOR REPLY WHICHEVER IS LONGER, FROM THE MAILING DA - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period w - Failure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 16(a). In no event, however, may a reply be tin 11 apply and will expire SIX (6) MONTHS from 12 cause the application to become ABANDONE	N. nely filed the mailing date of this communication. D (35 U.S.C. § 133).					
Status							
1) Responsive to communication(s) filed on 27 Ma	<u>arch 2006</u> .						
2a)⊠ This action is FINAL . 2b)☐ This	This action is FINAL . 2b) ☐ This action is non-final.						
·							
closed in accordance with the practice under E	x parte Quayle, 1935 C.D. 11, 4	53 O.G. 213.					
Disposition of Claims							
4)⊠ Claim(s) <u>5-11 and 14-26</u> is/are pending in the application.							
4a) Of the above claim(s) is/are withdrawn from consideration.							
5) Claim(s) is/are allowed.							
6) Claim(s) <u>5-11 and 14-26</u> is/are rejected.							
7) Claim(s) is/are objected to.	r alaction requirement	•					
8) Claim(s) are subject to restriction and/or	election requirement.						
Application Papers							
9)⊠ The specification is objected to by the Examine	г.						
10) ☐ The drawing(s) filed on is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.							
Applicant may not request that any objection to the							
Replacement drawing sheet(s) including the correct							
11)☐ The oath or declaration is objected to by the Ex	taminer. Note the attached Office	ACTION OF TOIM PTO-152.					
Priority under 35 U.S.C. § 119							
12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of:							
1. Certified copies of the priority documents have been received.							
2. Certified copies of the priority documents have been received in Application No							
3. Copies of the certified copies of the prior		ed in this National Stage					
application from the International Bureau		ad.					
* See the attached detailed Office action for a list of the certified copies not received.							
Attachment(s)	, , , , , , , , , , , , , , , , , , , 	(DTO 442)					
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948)	4) Interview Summary Paper No(s)/Mail D						
3) X Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)	· 🚎	Patent Application (PTO-152)					
Paper No(s)/Mail Date <u>0106, 0306</u> .	6)						

DETAILED ACTION

Specification

The claims are objected to because the words of the claims are crowded (too closely together) making reading difficult. Substitute claims with better spacing between the words is required.

A substitute specification in proper idiomatic English and in compliance with 37 CFR 1.52(a) and (b) is required. The substitute specification filed must be accompanied by a statement that it contains no new matter.

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 5-8, 14-16, and 20-26 are rejected under 35 U.S.C. 103(a) as being unpatentable over Raaijmakers et al., U.S. Patent 5,460,689 in view of Nowak et al., U.S. Patent 6,220,201, Qian et al., U.S. Patent 6,447,636 and Forster et al., EP 0 685 873 A1.

Raaijmakers et al. shows the invention substantially as claimed including a plasma processing method for performing plasma processing by using a plasma processing system comprising a chamber for housing a substrate-to-be-processed; a

belljar 12 disposed on the chamber in communication with the chamber and having a side wall and a top wall of an insulator; a conducting mount 18 disposed in the chamber, for the substrate to be processed to be mounted on; an antenna means 28 disposed on the outside of the side wall of the belljar, for generating induced electromagnetic fields in the belljar; a first high frequency electric power source 40 for supplying high frequency electric power to the antenna means; gas supply means (34,36a,36b) for supplying a plasma generating gas which is dissociated by the induced electromagnetic fields generated by the antenna means to be plasma, and a processing gas for the plasma processing; and a second high frequency power source 42 for applying high frequency power to the mount, high frequency electric power being supplied from the second high frequency electric power source to the mount to generate electric fields vertical to the substrate to be processed between the mount and the conducting member and generate plasmas.

Raaijmakers et al. does not expressly disclose a flat conducting member disposed above the top wall, opposed to the mount, being grounded, a Faraday shield disposed between the antenna means and the belljar, and high frequency electric power supplied to the mount and then supplied to the antenna. Nowak et al. discloses a flat conducting member 24 disposed above the top wall for capacitively coupling plasma to the chamber (see fig. 1 and its description), and igniting the plasma by supplying high frequency power to the mount and then high frequency to the antenna (see col. 4-lines 4-lines 27-31), where the conducting member can be grounded during this process (see col. 4-lines 62-64) In view of this disclosure, it would have been obvious to one of

ordinary skill in the art at the time the invention was made to modify the process of Raaijmakers et al. so as to have a flat conducting member disposed above the top wall and perform the ignition process as disclosed by Nowak et al. because this allows for the formation of a high quality plasma.

Regarding the Faraday shield and heating the substrate, Qian et al. discloses a Faraday shield 210 between the antenna and the chamber (see fig. 1 and its description), and a substrate heater (see col. 4-lines 29-37). In view of this disclosure, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify the process of Raaijmakers et al. modified by Nowak et al. to have a faraday shield between the antenna and the chamber and to heat the substrate while processing because in such a way capacitive coupling from the antenna can be prevented from entering the chamber and the process can be more effectively controlled by controlling the substrate temperature.

Regarding claims 14-15 and 20, Qian et al. discloses shutting down the capacitively coupled plasma power after the inductively coupled plasma is initiated (see col.). In view of this disclosure, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify the process of Raaijmakers et al. modified by Nowak et al. so as to shut down the capacitively coupled plasma as suggested by Qian et al. because in such a way an effective inductively coupled plasma with a small capacitively coupled portion can be maintained for inductively coupled plasma processing.

Moreover, neither Raaijmakers et al., Nowak et al., or Qian et al. disclose wherein the capacitive coupling is created using a conducting mount in the chamber which is solely grounded and not connected to high frequency power. Forster et al. discloses initiating capacitive coupling using a grounded conducting mount 180 opposed to a substrate and not connected to high frequency power (see fig. 3 and its description). In view of this disclosure, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify the process of Raaijmakers et al. modified by Nowak et al. and Qian et al. so as to create the capacitive coupling as taught by Forster et al. because such a generation technique forms an effective capacitively coupled plasma.

Claims 9 and 17 are rejected under 35 U.S.C. 103(a) as being unpatentable over Raaijmakers et al., U.S. Patent 5,460,689 in view of Nowak et al., U.S. Patent 6,220,201, Qian et al., U.S. Patent 6,447,636 and Forster et al., EP 0 685 873 A1 as applied to claims 5-8, 14-16, and 20-26 above, and further in view of Brcka, U.S. Patent 6,652,711.

Raaijmakers et al., Nowak et al., Qian et al., and Forster et al. are applied as above but do not expressly disclose using the plasma processing for removing natural oxide films from the substrate. Brcka discloses using a plasma system for removing natural oxide from the substrate (see col. 1-lines 15-19). In view of this disclosure, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify the process of Raaijmakers et al. modified by Nowak et al., Qian et al.

and Forster et al., so as to perform a process to remove native oxide from a substrate because as disclosed by Brcka, a plasma apparatus is commonly used for such a purpose.

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Claims 10-11 and 18-19 are rejected under 35 U.S.C. 103(a) as being unpatentable over Raaijmakers et al., U.S. Patent 5,460,689 in view of Nowak et al., U.S. Patent 6,220,201, Qian et al., U.S. Patent 6,447,636, Forster et al., EP 0 685 873 A1, and Brcka, U.S. Patent 6,652,711 as applied to claims 9 and 17 above, and further in view of Liu et al., U.S. Patent 6,776,170.

Raaijmakers et al., Nowak et al., Qian et al., Forster et al., and Brcka are applied as above but do not expressly disclose using argon and hydrogen to remove the native oxide. Liu et al. discloses removing native oxide using hydrogen and argon gas (see col. 3-line 66 to col. 4-line 14). In view of this disclosure, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify the process of Raaijmakers et al. modified by Nowak et al., Qian et al., Forster et al., and Brcka so as to remove the native oxide using hydrogen and argon gasses because Liu et al. teaches that such gasses are suitable for the intended purpose of removing native oxide from a substrate.

Concerning claims 11 and 19, note that in Raaijmakers et al. the first high-frequency electric power source is connected to an upper end portion of the antenna means.

Response to Arguments

Applicant's arguments with respect to claims 5-11 and 14-26 have been considered but are moot in view of the new ground(s) of rejection.

Conclusion

Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Luz L. Alejandro whose telephone number is 571-272-1430. The examiner can normally be reached on Monday to Thursday from 7:30 to 6:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Parviz Hassanzadeh can be reached on 571-272-1435. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

Luz L. Alejandro Primary Examiner Art Unit 1763

June 12, 2006